

**SE9435****P-Channel Enhancement Mode Power MOSFET****General Description**

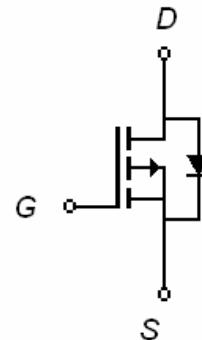
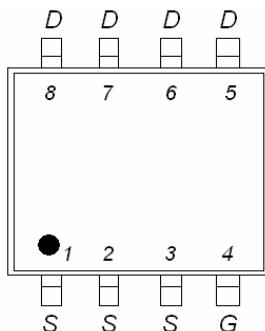
The MOSFETs from SINO-IC provide the best combination of fast switching, low on-resistance and cost-effectiveness.

**Applications**

- Power management in nomadic equipment
- DC-DC converters
- Battery powered systems
- Motor drive

**Features**

- $V_{DS} = -30\text{ V}$
- $I_D = -5.3\text{ A}$
- $R_{DS(ON)} = 0.050\text{ }\Omega @ V_{GS} = -10\text{ V}$
- Low gate charge.
- Fast switching speed.
- Extremely low  $R_{DS(ON)}$
- High power and current handling capability

**SOP-8****Absolute Maximum Ratings**

Parameter	Symbol	Rating	Units
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>3</sup> @ $T_A=25^\circ\text{C}$	$I_D$	-5.3	A
Continuous Drain Current <sup>3</sup> @ $T_A=70^\circ\text{C}$	$I_D$	-4.7	A
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	-20	A
Power Dissipation @ $T_A=25^\circ\text{C}$	$P_D$	2.5	W
Linear Dearing Factor		0.02	W/ $^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 to 150	$^\circ\text{C}$
Operating Junction Temperature Range	$T_J$	-55 to 150	$^\circ\text{C}$

**Thermal Characteristics**

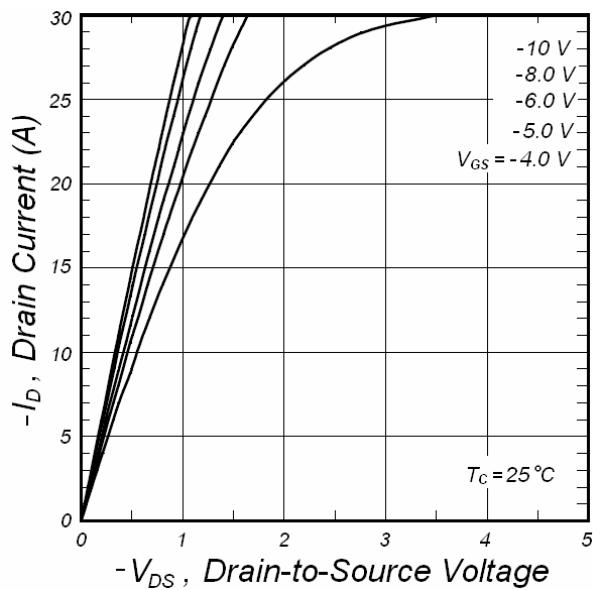
Parameter	Symbol	Max	Units
Thermal Resistance Junction-to-Ambient <sup>3</sup>	$R_{thj-amb}$	50	$^\circ\text{C/W}$

<b>Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)</b>						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> = -250 μA, V <sub>GS</sub> =0 V	-30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -30 V, V <sub>GS</sub> =0 V			-1	μA
		V <sub>DS</sub> = -24 V, V <sub>GS</sub> =0 V (T <sub>J</sub> =70°C)			-25	μA
I <sub>GS</sub>	Gate-Body leakage current	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V			±100	nA
V <sub>GSS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> I <sub>D</sub> = -250 μA	-1		-3	V
R <sub>DSON</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -5.3 A			50	mΩ
		V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -4.2A			90	mΩ
g <sub>F</sub>	Forward Transconductance	V <sub>DS</sub> = -10V, I <sub>D</sub> = -5.3 A		10		S
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> = -2.6 A, V <sub>GS</sub> = 0 V			-1.2	V
I <sub>S</sub>	Body-Diode Continuous Current	V <sub>D</sub> =V <sub>G</sub> =0V, V <sub>S</sub> =-1.2 V			-2.08	A
<b>DYNAMIC PARAMETERS</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> = -15 V, f=1MHz		790		pF
C <sub>oss</sub>	Output Capacitance			440		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			120		pF
<b>SWITCHING PARAMETERS</b>						
Q <sub>g</sub>	Total Gate Charge <sup>2</sup>	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -15V, I <sub>D</sub> = -5.3A		20		nC
Q <sub>gs</sub>	Gate Source Charge			3.5		nC
Q <sub>gd</sub>	Gate Drain Charge			2		nC
t <sub>d(on)</sub>	Turn-On DelayTime <sup>2</sup>	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -15V, I <sub>D</sub> = -1A R <sub>D</sub> =15Ω, R <sub>G</sub> =6Ω		12		ns
t <sub>r</sub>	Turn-On Rise Time			20		ns
t <sub>d(off)</sub>	Turn-Off DelayTime			45		ns
t <sub>f</sub>	Turn-Off Fall Time			47		ns

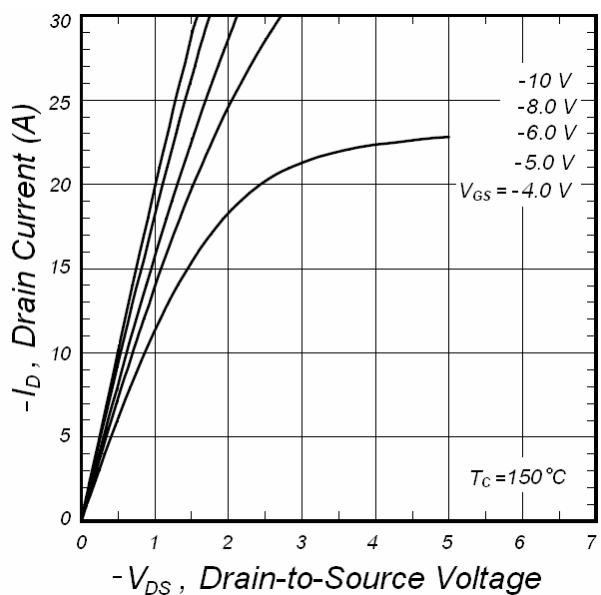
Notes:

1. Pulse width limited by Max. junction temperature.
2. Pulse width≤300us, duty cycle≤2%.
3. Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board; 125°C/W when mounted on Min. copper pad

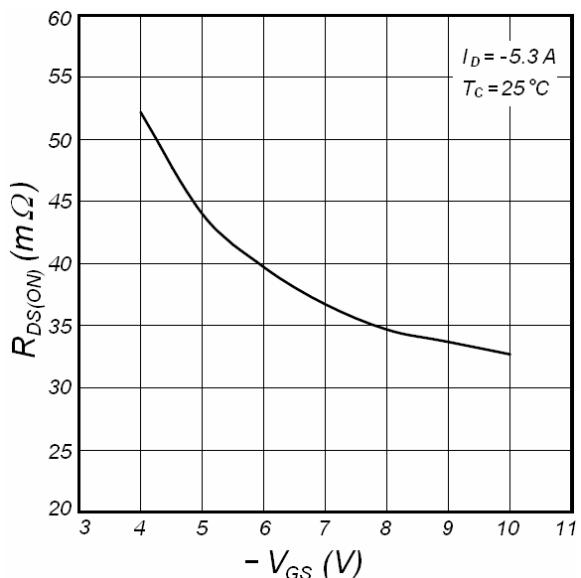
## Typical Characteristics



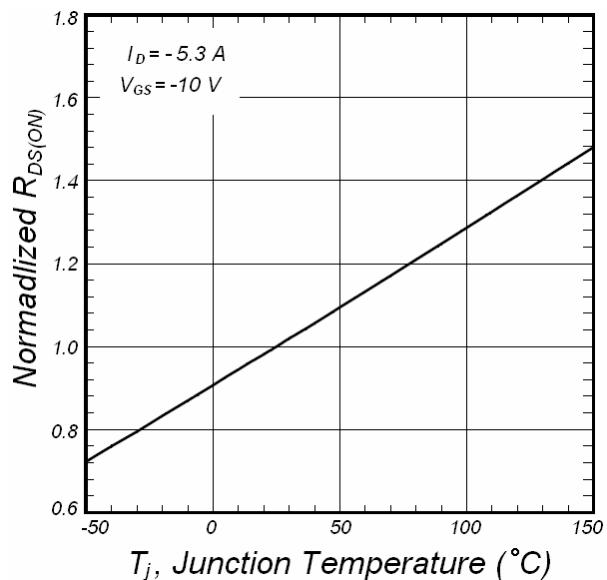
**Fig1. Typical output characteristics**



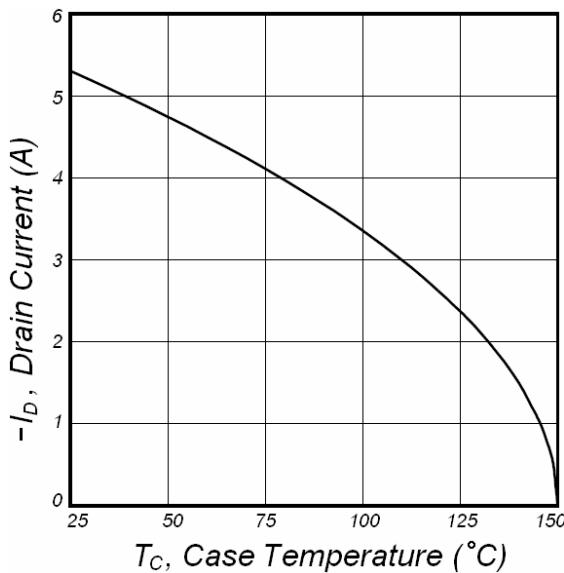
**Fig2. Typical output characteristics**



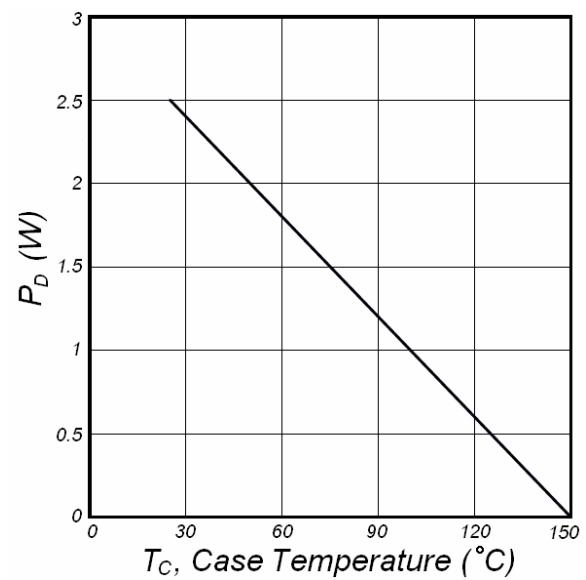
**Fig3. On-Resistance v.s. Gate Voltage**



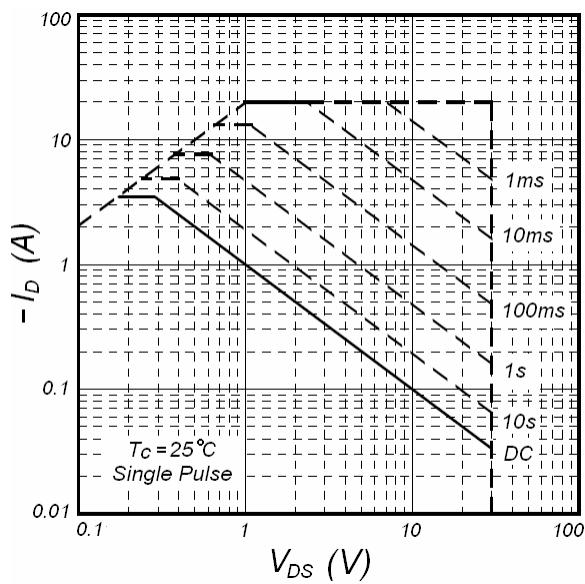
**Fig4. Normalized On-Resistance v.s. Junction Temperature**



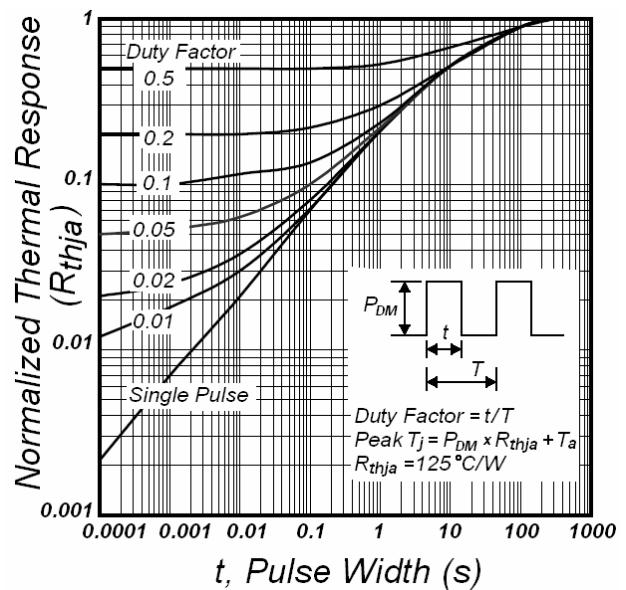
**Fig5. Maximum Drain Current v.s. Case Temperature**



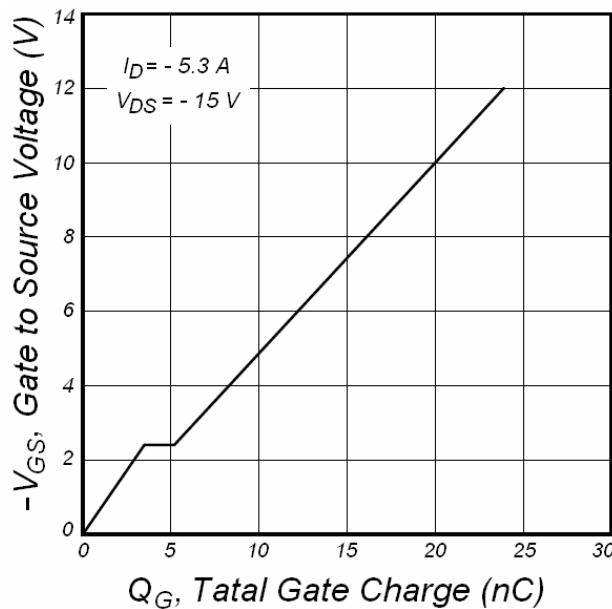
**Fig6. Typical Power Dissipation**



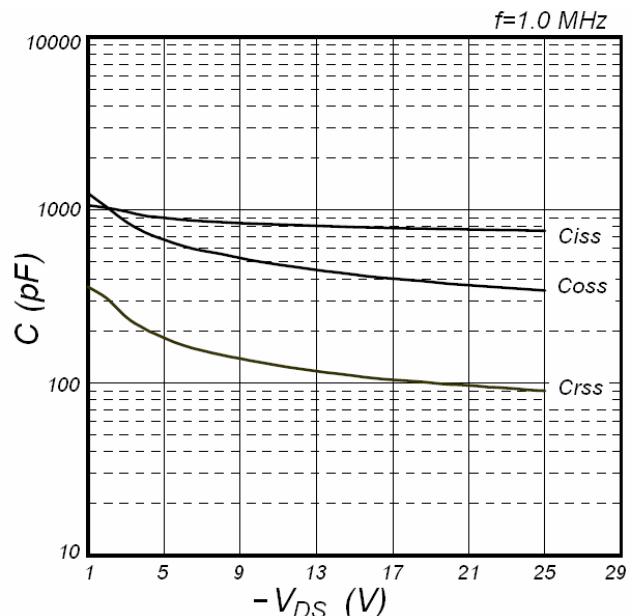
**Fig7. Maximum Safe Operating Area**



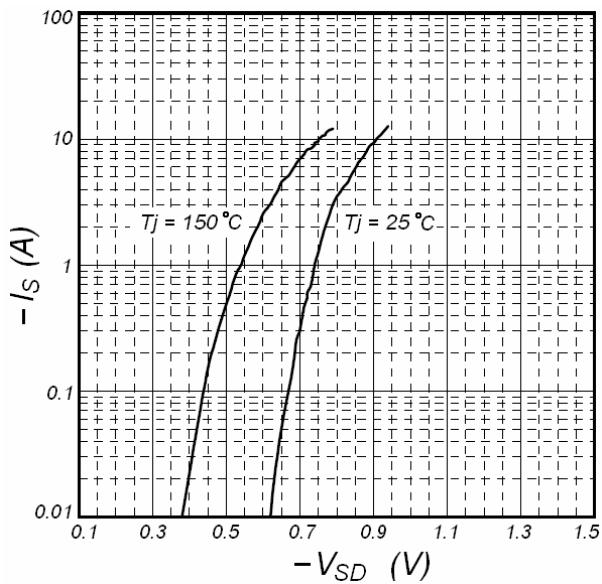
**Fig8. Effective Transient Thermal Impedance**



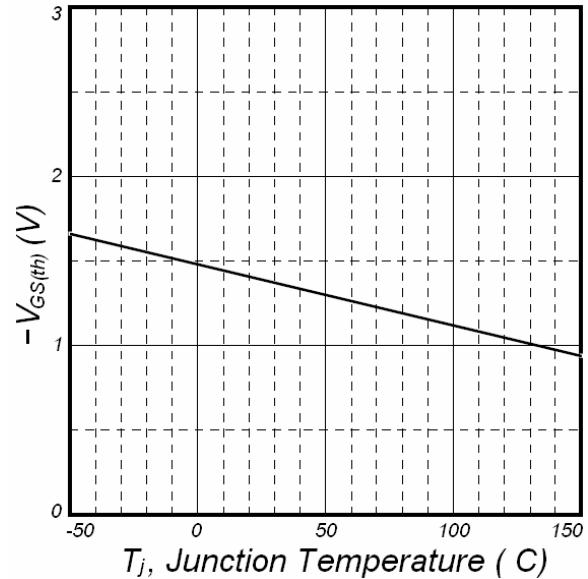
**Fig9. Gate Charge Characteristics**



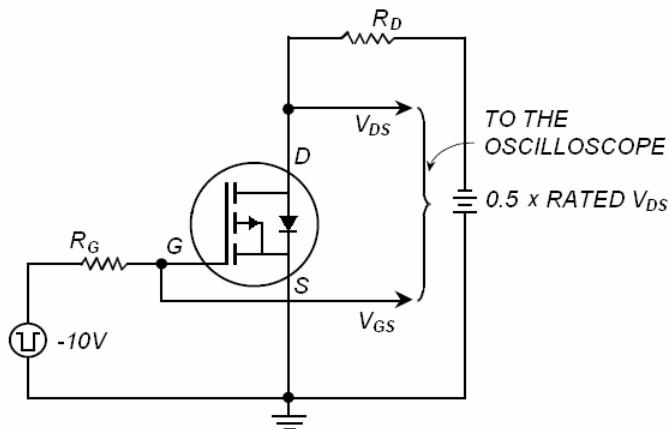
**Fig10. Typical Capacitance Characteristics**



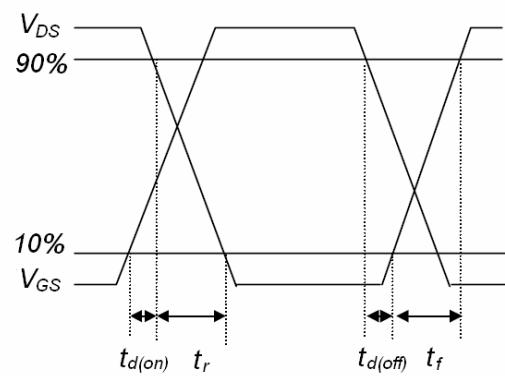
**Fig11. Forward Characteristic of Reverse Diode**



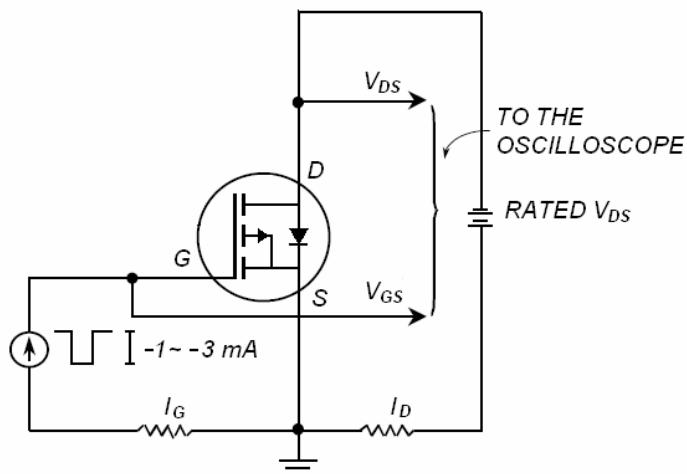
**Fig12. Gate Threshold Voltage v.s. Junction Temperature**



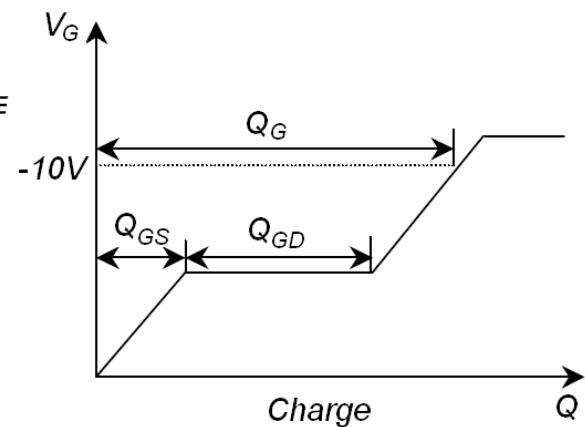
**Fig13. Switching Time Circuit**



**Fig14. Switching Time Waveform**



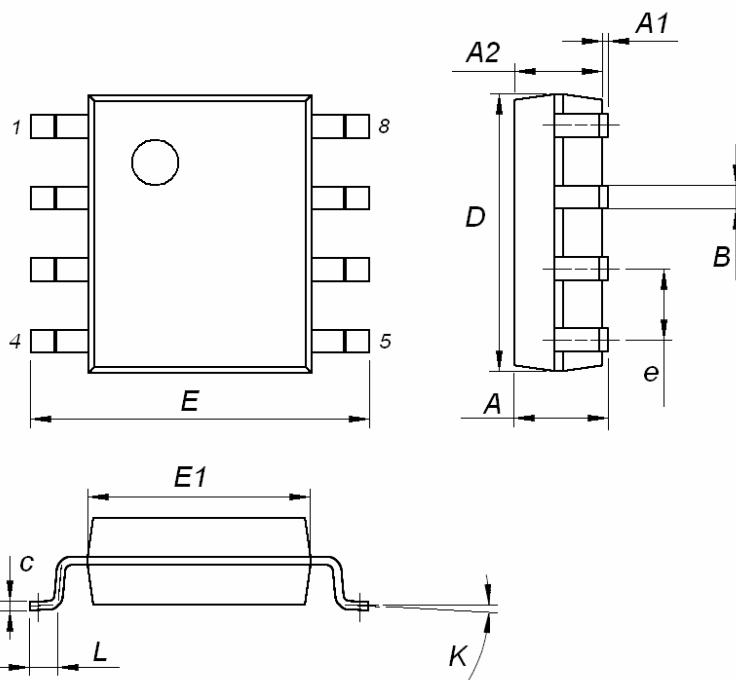
**Fig15. Gate Charge Circuit**



**Fig16. Gate Charge Waveform**

**SOP-8 MECHANICAL DATA**

DIM	Millimeters		
	MIN	TYP	MAX
A			1.75
A1	0.10		0.25
A2	1.35	1.55	1.75
B	0.35	0.42	0.49
C	0.19		0.25
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.95	4.00
e		1.27	
L	0.40		0.90
K	0°		8°



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